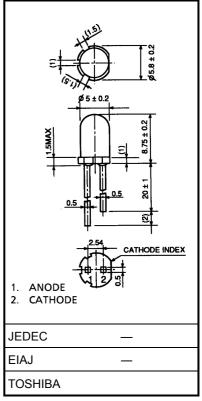
TOSHIBA LED Lamp InGaAlP Red Light Emission

TLSH156P

Panel Circuit Indicator

- 5mm diameter(T1-3 / 4)
- InGaAℓP red LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity red light emission Recommended forward current: IF = $1 \sim 20 \text{mA(DC)}$
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- High power luminous intensity
- Without stand-offs
- Applications: Suitable for outdoor message signboard, safety equipment, automotive use.



Weight/: 0.31 g

Maximum Ratings (Ta = 25°C)

| Characteristic | Symbol | Rating | Unit |
|-----------------------------|------------------|---------|------|
| Forward current (DC) | ١ _F | 50 | mA |
| Reverse voltage | V _R | 4 | V |
| Power dissipation | PD | 125 | mW |
| Operating temperature range | T _{opr} | -30~85 | °C |
| Storage temperature range | T _{stg} | -40~120 | °C |

Electrical And Optical Characteristics (Ta = 25°C)

| Characteristic | | Symbol | Test Condition | | Min | Тур. | Max | Unit |
|--------------------------|--------------|------------------|-----------------------|--------|-----|------|------|------|
| Forward voltage | | VF | I _F = 20mA | | _ | 2.1 | 2.5 | V |
| Reverse current | | I _R | V _R = 4V | | _ | _ | 50 | μA |
| Luminous intensity | TLSH156P | - I _V | I _F = 20mA | (Note) | 476 | 1400 | _ | mcd |
| | TLSH156P(RS) | | | | 476 | | 2300 | |
| Peak emission wavelength | | λ _P | I _F = 20mA | | _ | 623 | _ | nm |
| Spectral line half width | | Δλ | I _F = 20mA | | _ | 15 | _ | nm |
| Dominant Wavelength | | λ _d | I _F = 20mA | | _ | 613 | _ | nm |

(Note): Lamps are classified into the following ranks according to their luminous intensity.

Measurement tolerance for each limit is ±15%.

R: 560–1120mcd, S: 1000–2000mcd, T: 1800–3600mcd.

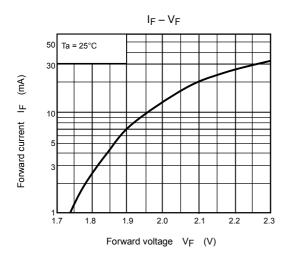
Unit in mm

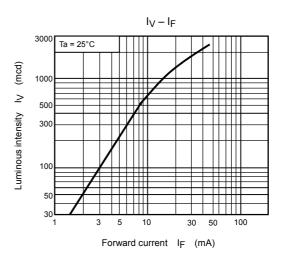
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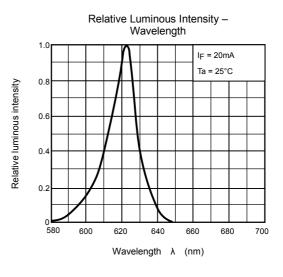
Precaution

- Please be careful of the followings
- Soldering temperature: 260°C max Soldering time: 3s max
- (Soldering portion of lead: Up to 2mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

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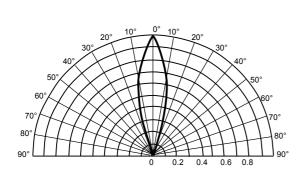


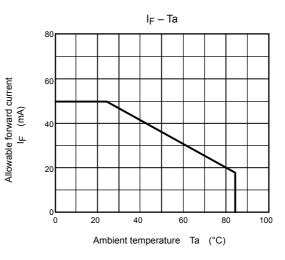




Radiation Pattern

Ta = 25°C





RESTRICTIONS ON PRODUCT USE

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